



1N5819HW

### 1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

## **Features**

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Application
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 4)

## **Mechanical Data**

- Case: SOD-123
- Plastic Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode Band
- Leads: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.01 grams (approximate)



Top View

### **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$		
Working Peak Reverse Voltage @ I <sub>R</sub> = 1.0mA	$V_{RWM}$	40	V
DC Blocking Voltage	$V_R$		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	28	V
Average Rectified Output Current @ T <sub>L</sub> = 90°C	I <sub>O</sub>	1.0	A
Repetitive Peak Forward Current		1.5	^
$t_{p \le 1} \text{ms}, \delta \le 0.5$	IFRM	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms	l=a	25	Δ
Single Half Sine-Wave Superimposed on Rated Load	IFSM	25	^

### Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	$P_{D}$	450	mW
Typical Thermal Resistance Junction to Ambient (Note 2)	$R_{ hetaJA}$	222	°C/W
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-65 to +125	°C

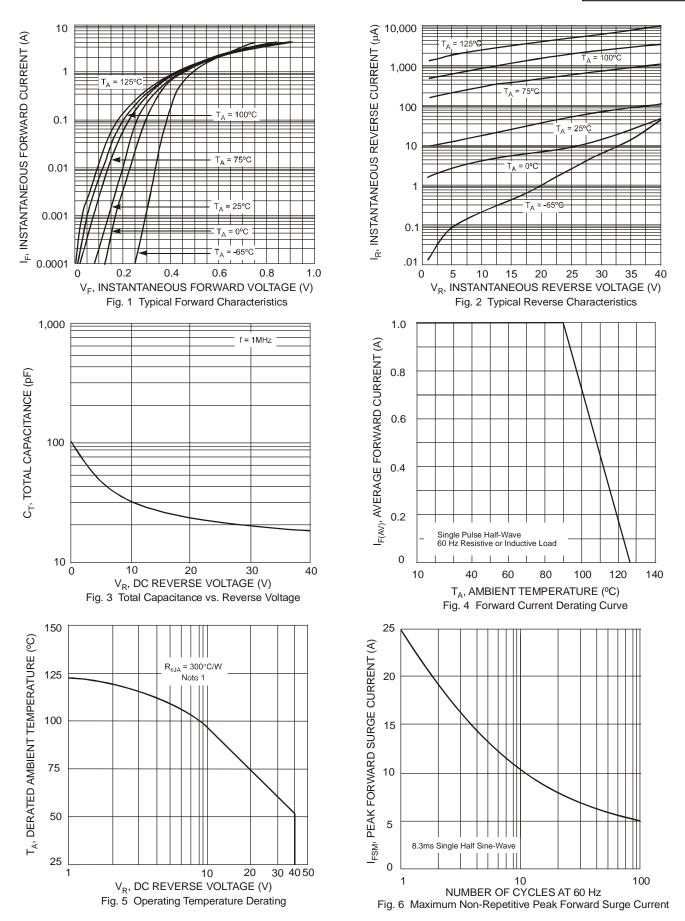
# **Electrical Characteristics** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 3)	$V_{(BR)R}$	40		_	>	$I_R = 1.0 \text{mA}$
		_		0.320		$I_F = 0.1A$
Forward Voltage	VF	_	_	0.450	V	I <sub>F</sub> = 1.0A
		_	_	0.750		$I_F = 3.0A$
	I <sub>R</sub>	_	_	1.0	mA	$V_R = 40V, T_A = 25^{\circ}C$
		_	_	10	mA	$V_R = 40V, T_A = 100^{\circ}C$
Reverse Leakage Current (Note 3)		_	10	50	μΑ	$V_R = 4V, T_A = 25^{\circ}C$
Reverse Leakage Current (Note 3)		_	1	2	mA	$V_R = 4V, T_A = 100^{\circ}C$
		_	15	75	μΑ	$V_R = 6V, T_A = 25^{\circ}C$
		_	1.5	3	mA	V <sub>R</sub> = 6V, T <sub>A</sub> = 100°C
Total Capacitance	Ст	_	50	60	pF	$V_R = 4V$ , $f = 1.0MHz$

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Device mounted on FR-4 PC Board, 2"x2", 2 oz. Copper, single sided, Cathode pad dimensions 0.75"x1.0", Anode pad dimensions 0.25"x1.0".
- 3. Short duration pulse test used to minimize self-heating effect.
- Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.





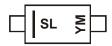


## Ordering Information (Note 5)

Part Number	Case	Packaging
1N5819HW-7-F	SOD-123	3000/Tape & Reel

Notes:  $5.\ For\ packaging\ details,\ go\ to\ our\ website\ at\ http://www.diodes.com/datasheets/ap02007.pdf.$ 

# **Marking Information**

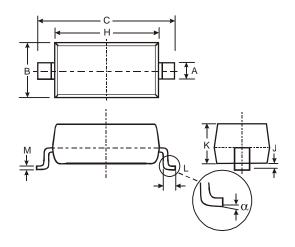


SL = Product Type Marking Code YM = Date Code Marking Y = Year (ex: N = 2002) M = Month (ex: 9 = September)

Date Code Key

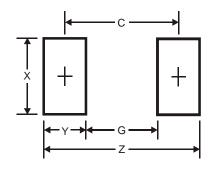
Year	2002	2003	2004	2005	200	6 20	07	2008	2009	2010	2011	2012
Code	N	Р	R	S	Т	ı	J	V	W	Х	Υ	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	g Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

## **Package Outline Dimensions**



SOD-123							
Dim	Dim Min Max						
Α	0.55	Тур					
В	1.40 1.70						
C	3.55 3.85						
Н	2.55 2.85						
Ĺ	0.00 0.10						
K	1.00 1.35						
Г	0.25 0.40						
M	0.10	0.15					
α	0	8°					
All Dimensions in mm							

# **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	4.9
G	2.5
Х	0.7
Y	1.2
С	3.7



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